## 504468664 07/21/2017 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT		
CONVEYING PARTY	DATA				
		Name	Execution Date		
TIMO MUELLER			06/12/2017		
MICHAEL GEHMLICH			06/06/2017		
FRANK FALLER		06/05/2017			
RECEIVING PARTY	ΟΑΤΑ				
Name:					
Street Address:	HANNS	HANNS-SEIDEL-PLATZ 4			
City:	MUNIC	MUNICH			
State/Country:	GERM	GERMANY			
Postal Code:	81737	81737			
PROPERTY NUMBER	RS Total: 1				
Property Type		Number	7		
		15545541			
Fax Number:		(248)358-3351 • <b>the e-mail address first; if that is u</b>	nsuccessful it will be sent		
		; if that is unsuccessful, it will be s			
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		-			
			WSAGN0130PUSA		
NAME OF SUBMITTER	٦.		WILLIAM G. CONGER		
SIGNATURE:			/William G. Conger/		
DATE SIGNED:		07/21/2017			
Fotal Attachments: 2		nmont#pogo1 tif			
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## ASSIGNMENT AND DECLARATION (37 C.F.R. 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76)

## Title of Invention EPITAXIALLY COATED SEMICONDUCTOR WAFER AND METHOD FOR PRODUCING AN EPITAXIALLY COATED SEMICONDUCTOR WAFER

As a below named inventor, I hereby declare that:

This declaration is directed to:

The attached application, or

United States application or PCT international application number
 <u>PCT/EP2016/050760</u> filed on January 15, 2016.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I am aware of the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I do hereby assign, sell and set over to <u>SILTRONIC AG</u>, a corporation organized and existing under the laws of the state or country of <u>Germany</u>, and having a place of business at <u>Hanns-Seidel-Platz 4</u>, <u>81737</u> <u>Munich</u>, <u>Germany</u>, hereinafter referred to as the ASSIGNEE, its successors, assigns or other legal representatives, my entire right, title and interest, domestic and foreign, in and to the inventions and discoveries in the above-identified application including the right of said ASSIGNEE, its successors, assigns or other legal representatives to make applications and to receive Letters Patent for said inventions and discoveries in any and all foreign countries in its or their own name or names, or in my name, at its or their election, and I hereby assign, sell and set over to said ASSIGNEE, its successors, assigns or other legal representatives, all rights of priority, including any provisional applications, in and to said inventions and discoveries in all countries, including all applications claiming benefit of the filing date hereof, continuations, continuations-in-part, divisionals, reexaminations and reissue applications.

And I hereby agree for myself, my heirs, successors, assigns or other legal representatives to execute any and all papers, including applications for Letters Patent of any and all kinds and in any and all countries and to perform any and all acts which said ASSIONEE, its successors, assigns or other legal representatives may deem necessary to secure thereto the rights herein assigned, sold and set over.

And I hereby represent and warrant that I have not granted any rights inconsistent with the rights granted herein.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years or both.

LEGAL NA	ME OF INVENTOR Timo MUELLER	Date: 12,6.17	
Signature:	<u> </u>		
Page <u>1</u> of <u>2</u> (	(Supplemental Sheet with Additional Joint Inventors is att	ached if necessary)	
Note: An Ap	plication Data Sheet (PTO/SB/14 or equivalent), including nami	ing the entire inventive entity, must accompany this form.	

PATENT REEL: 043066 FRAME: 0438

		Attorney Docket Nu	uber WSAGN01308A H-TP-I/BGH/ST/AE
SUPPLEMENTAL SHEET FOR ASSIGNMENT AND DECLARATION (37 C.F.R. 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76)			Additional Inventors Fage <u>2</u> of <u>2</u>
Title of Invention	EPITAXIALLY COATED SE PRODUCING AN EPITAXIAL		R WAFER AND METHOD FOR MICONDUCTOR WAFER
Legal Name of Add	litional Joint Inventor:		
Inventor: <u>Michae</u> Signature:	I GEHMLICH	Daie:	<u>06.06.20.17-</u>
Legal Name of Add	litional Joint Inventor:		
Inventor: <u>Frank F</u> Signature: <u>4</u>	ALLER	Date:	<u>05, 06, 20, 11</u>